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Avionicsmanagement – Managementplan – Del 1: Forberedelse og vedligeholdelse af managementplan for elektroniske komponenter

Process management for avionics – Management
plan – Part 1: Preparation and maintenance of an
electronic components management plan

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EUROPÄISCHE NORM

December 2018

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English Version

Process management for avionics - Management plan - Part 1:
Preparation and maintenance of an electronic components
management plan
(IEC 62239-1:2018)

Gestion des processus pour l'avionique - Plan de gestion -
Partie 1: Préparation et maintenance d'un plan de gestion
des composants électroniques
(IEC 62239-1:2018)

Luftfahrtelektronik-Prozessmanagement - Managementplan
- Teil 1: Erarbeitung und Instandhaltung eines
Managementplanes für elektronische Bauelemente
(IEC 62239-1:2018)

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European foreword

The text of document 107/320/CDV, future edition 1 of IEC 62239-1, prepared by IEC/TC 107 "Process management for avionics" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 62239-1:2018.

The following dates are fixed:

- latest date by which the document has to be implemented at national level by publication of an identical national standard or by endorsement (dop) 2019-07-29
- latest date by which the national standards conflicting with the document have to be withdrawn (dow) 2021-10-29

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IEC 60068-2-58	NOTE	Harmonized as EN 60068-2-58
IEC 60695-11-5	NOTE	Harmonized as EN 60695-11-5
IEC 61193-2	NOTE	Harmonized as EN 61193-2
IEC 61340-5-1	NOTE	Harmonized as EN 61340-5-1
IEC/TR 61340-5-2	NOTE	Harmonized as CLC/TR 61340-5-2
IEC 61760-4	NOTE	Harmonized as EN 61760-4
IEC 61967 (series)	NOTE	Harmonized as EN 61967 (series)
IEC 61967-1	NOTE	Harmonized as EN 61967-1
IEC 62435-1	NOTE	Harmonized as EN 62435-1
IEC 62132 (series)	NOTE	Harmonized as EN 62132 (series)
IEC 62402	NOTE	Harmonized as EN 62402
IEC 62435-1	NOTE	Harmonized as EN 62435-1
ISO 9000	NOTE	Harmonized as EN ISO 9000
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(normative)

Normative references to international publications with their corresponding European publications

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NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: www.cenelec.eu.

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 62396	series	Process management for avionics - Atmospheric radiation effects	-	-
IEC 62396-1	2016	Process management for avionics - Atmospheric radiation effects - Part 1: Accommodation of atmospheric radiation effects via single event effects within avionics electronic equipment	-	-
IEC/TS 62647-1	-	Process management for avionics - Aerospace and defence electronic systems containing lead-free solder - Part 1: Preparation for a lead-free control plan	-	-
GEIA-STD-0005-1	-	Performance Standard for Aerospace and High Performance Electronic Systems Containing Lead-Free Solder	-	-
IPC/JEDEC J-STD-20	-	Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices	-	-

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**Process management for avionics – Management plan –
Part 1: Preparation and maintenance of an electronic components management
plan**

**Gestion des processus pour l'avionique – Plan de gestion –
Partie 1: Préparation et maintenance d'un plan de gestion des composants
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INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Process management for avionics – Management plan –
Part 1: Preparation and maintenance of an electronic components management
plan**

**Gestion des processus pour l'avionique – Plan de gestion –
Partie 1: Préparation et maintenance d'un plan de gestion des composants
électroniques**

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INTERNATIONAL ELECTROTECHNICAL COMMISSION

**PROCESS MANAGEMENT FOR AVIONICS –
MANAGEMENT PLAN –**

**Part 1: Preparation and maintenance of
an electronic components management plan**

FOREWORD

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International Standard IEC 62239-1 has been prepared by IEC technical committee 107: Process management for avionics.

IEC 62239-1 cancels and replaces IEC TS 62239-1 published in 2015.

This first edition cancels and replaces the first edition of IEC TS 62239-1 published in 2015. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- a) added references to SAE EIA-STD-4899, IECQ OD 3702, IECQ OD 3407-1, IEC TR 62240-2, IECQ component schemes, SAE AS6081, SAE AS6171, GEIA-STD-0005-1 GEIA STD 0008;

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- b) replaced Annex C (which was transferred into IEC TR 62240-2) with a cross-reference table to SAE EIASTD4899 rev C clauses/subclauses for guidance purposes only;
- c) added the analysis of component technical erratum in 4.8.2;
- d) updated Bibliography and reference documents.

The text of this international standard is based on the following documents:

CDV	Report on voting
107/320/CDV	107/333/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all the parts in the IEC 62239 series under the general title *Process management for avionics – Management plan*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
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INTRODUCTION

This document provides the structure for avionics equipment manufacturers, subcontractors, maintenance facilities, and other aerospace component users to develop their own electronic component management plan (ECMP), hereinafter also referred to as 'plan'. This document states objectives to be accomplished. The plan does not describe specific requirements and those who prepare plans in compliance with this document will document processes that are the most effective and efficient for them in accomplishing the objectives of this document. In order to allow flexibility in implementing and updating the documented processes, plan owners are encouraged to refer to their own internal process documents instead of including detailed process documentation within their plans.

NOTE The equipment manufacturer, often called in the industry the original equipment manufacturer (OEM) is in general considered as the plan owner.

This component management document is intended for aerospace users of electronic components. This document is not intended for use by the manufacturers of electronic components. Components selected and managed according to the requirements of a plan compliant with this document may be approved by the concerned parties for the proposed application, and for other applications with equal or less severe requirements.

Organizations that prepare such plans may prepare a single plan and use it for all relevant products supplied by the organization or may prepare a separate plan for each relevant product or customer.

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PROCESS MANAGEMENT FOR AVIONICS – MANAGEMENT PLAN –

Part 1: Preparation and maintenance of an electronic components management plan

1 Scope

This part of IEC 62239 defines the requirements for developing an electronic components management plan (ECMP) to guarantee to customers that all of the electronic components in the equipment of the plan owner are selected and applied in controlled processes compatible with the end application and that the technical requirements detailed in Clause 4 are accomplished.

In general, the plan owner of a complete electronic components management plan (ECMP) is the avionics original equipment manufacturer (OEM).

NOTE SAE EIA-STD-4899 can be used to comply with the requirements of IEC 62239-1 where applicable (see Annex C), to enable the plan owner to harmonise its plan for both documents.

This document provides an aid in the aerospace certification process.

Although developed for the avionics industry, this process can be applied by other industrial sectors.

2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 62396 (all parts), *Process management for avionics – Atmospheric radiation effects*

IEC 62396-1:2016, *Process management for avionics – Atmospheric radiation effects – Part 1: Accommodation of atmospheric radiation effects via single event effects within avionics electronic equipment*

IEC TS 62647-1, *Process management for avionics – Aerospace and defence electronic systems containing lead-free solder – Part 1: Preparation for a lead-free control plan*

GEIA-STD-0005-1, *Performance Standard for Aerospace and High Performance Electronic Systems Containing Lead-Free Solder*

IPC/JEDEC J-STD-20, *Moisture/Reflow Sensitivity Classification for Nonhermetic Solid State Surface Mount Devices*